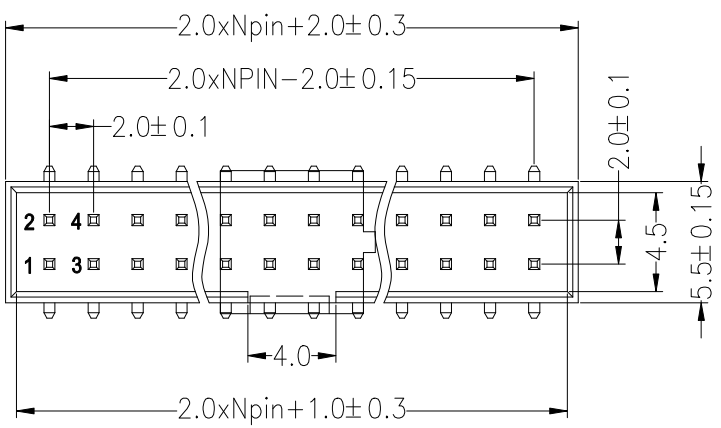
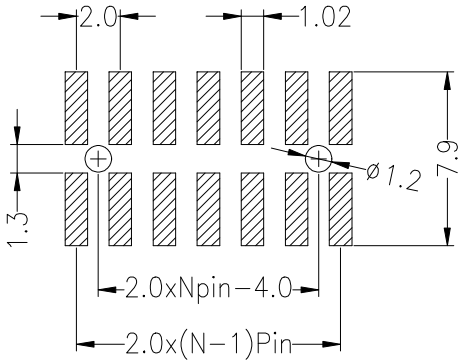
HSF RoHS FILE NO:E362810

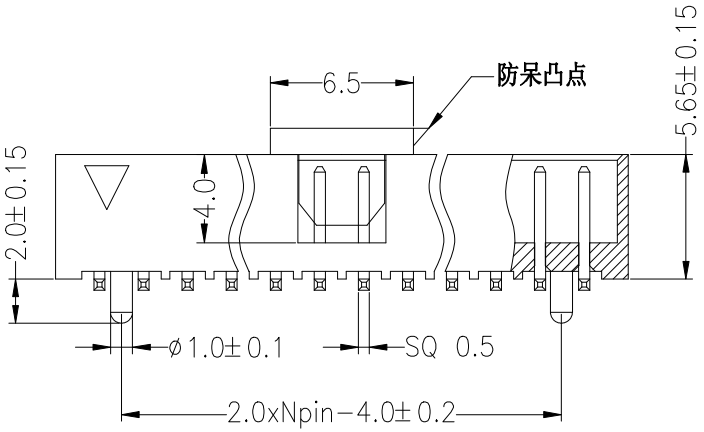
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:400V AC/DC
Insulation Resistance:800MΩ Min
Operation Temperature:−40°c to +105°c

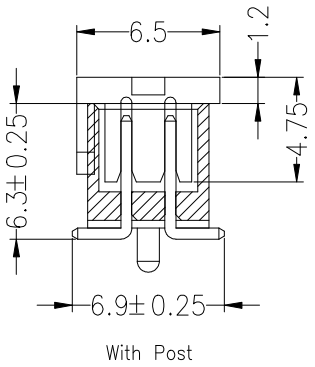
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



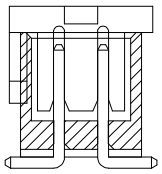
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)







With Post


Without Post

Ordering Information

3222 XX M XX X B K00 X 0X

- No.of Pins: 6--64
- Contact Plating: G0:Gold Flash; G1:1U" Gold; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; S0:Gold Flash/Tin
- Insulator Material Option: C=BK−PA6T; D=BK−PA46; E=BK−PA9T; F=BK−LCP
- Packing: 0=PE Bag; A=Tray; T=Tube; P=Tube+Cap; R=Reel+Cap

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2018.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	18.03.28
X.X	± 0.30			
X.XX	± 0.20	CHECK		
X.XXX	± 0.10			
Angle	± 3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3222XXMXXXBK00X0X
TITLE:	2.0Box Header Npin H5.65 SMT 短体